Silicon P-Channel MOS FET

HITACHI

ADE-208-1181 (Z) 1st. Edition Mar. 2001

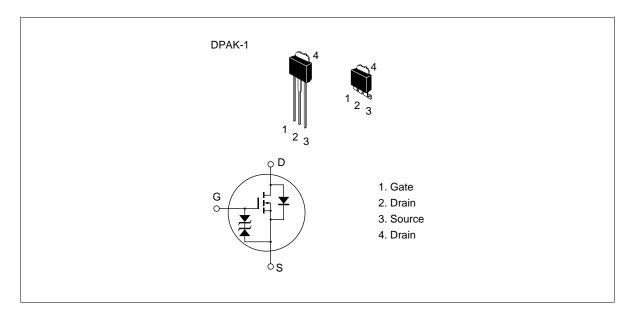
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator, DC-DC converter and ultrasonic power oscillators

Outline





Absolute Maximum Ratings (Ta = 25° C)

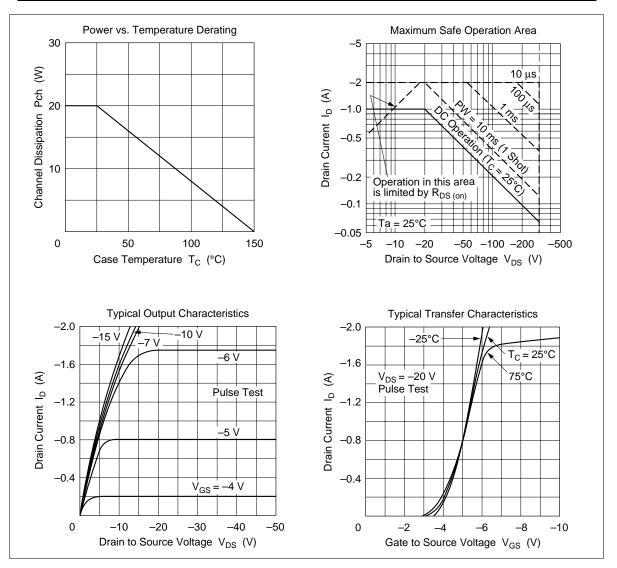
ltem	Symbol	Ratings	Unit	
Drain to source voltage	V _{DSS}	-300	V	
Gate to source voltage	V _{GSS}	±20	V	
Drain current	I _D	-1	А	
Drain peak current	I _{D(pulse)}	-2	А	
Body to drain diode reverse drain current	I _{DR}	-1	А	
Channel dissipation	Pch*1	20	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	
	-			

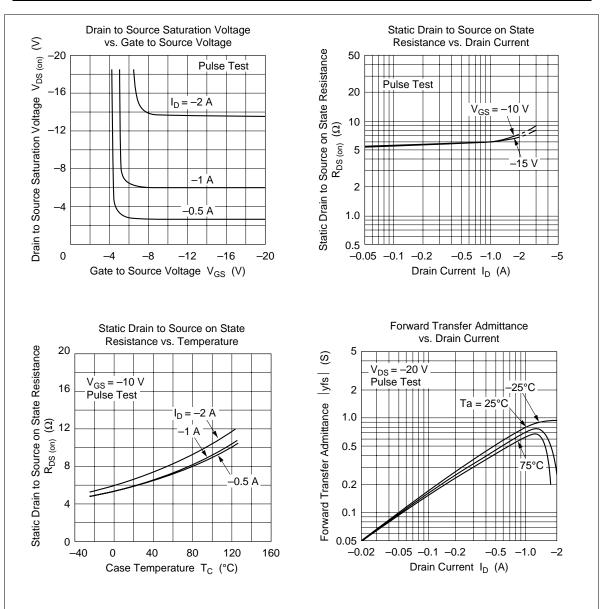
Note: 1. Value at $T_c = 25^{\circ}C$

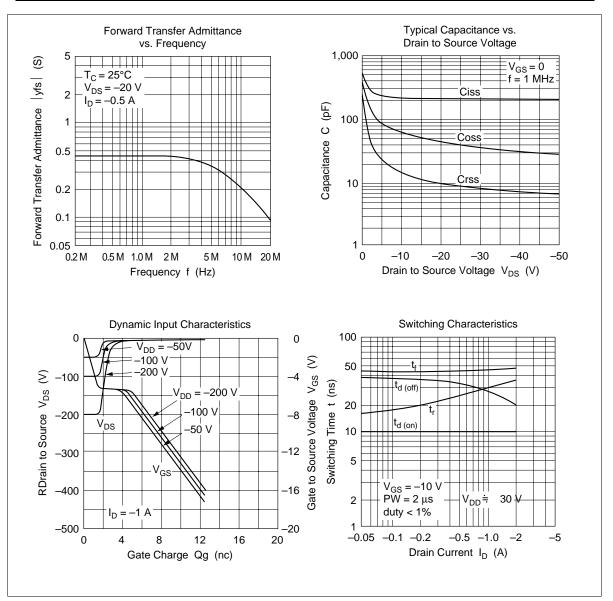
Electrical Characteristics (Ta = 25°C)

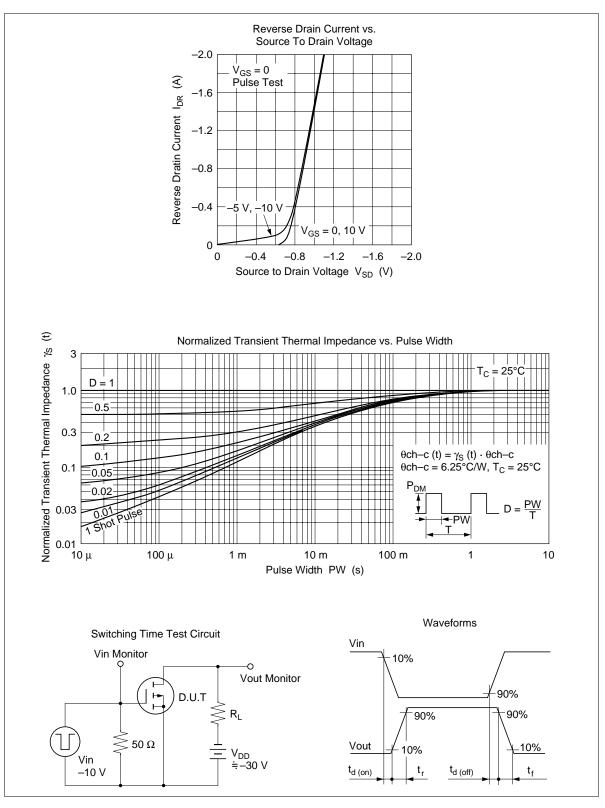
Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Drain to source breakdown voltage	$V_{\rm (BR)DSS}$	-300	_	_	V	$I_{\rm D} = -10$ mA, $V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}			±10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	-100	μA	$V_{\rm DS} = -240$ V, $V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	-2.0	_	-4.0	V	$I_{\rm D} = -1 \text{ mA}, V_{\rm DS} = -10 \text{ V}$
Static drain to source on state resistance	$R_{\text{DS(on)}}$	—	6.0	8.5		$I_{\rm D} = -0.5 \text{ A}, V_{\rm GS} = -10 \text{ V}^{*1}$
Forward transfer admittance	y _{fs}	0.25	0.4	_	S	$I_{\rm D} = -0.5 \text{ A}, V_{\rm DS} = -20 \text{ V}^{*1}$
Input capacitance	Ciss	_	235	_	pF	$V_{DS} = -10 V, V_{GS} = 0,$
Output capacitance	Coss	_	65		pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	16		pF	
Turn-on delay time	t _{d(on)}	_	10		ns	$I_{\rm D} = -0.5 \text{ A}, V_{\rm GS} = -10 \text{ V},$
Rise time	t,	_	25	_	ns	$R_{L} = 60$
Turn-off delay time	$t_{d(off)}$	_	35		ns	
Fall time	t _r	_	45	_	ns	
Body to drain diode forward voltage	V_{DF}	—	-0.9	_	V	$I_F = -1 A, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	—	200	—	ns	$I_F = -1 \text{ A}, V_{GS} = 0,$ $di_F/dt = 50 \text{ A}/\mu \text{s}$
Noto: 1 Dulas test						

Note: 1. Pulse test

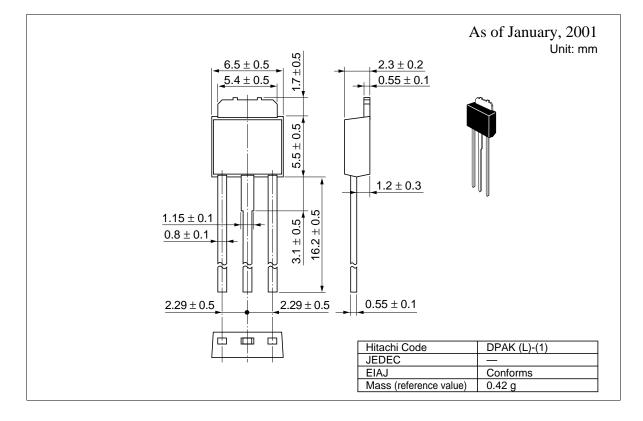


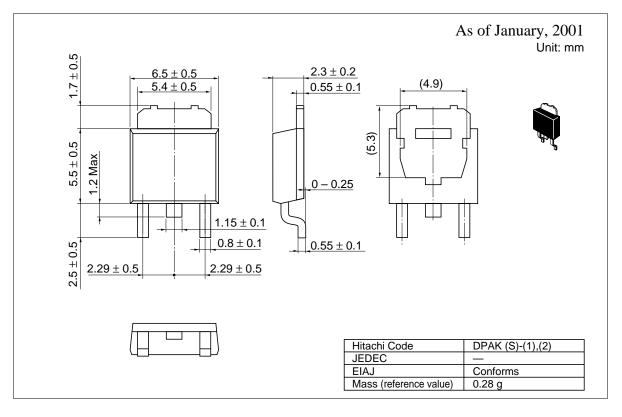






Package Dimensions





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